

#### **Automotive Grade N-channel SiC power MOSFET**

V <sub>DSS</sub>	1200V
R <sub>DS(on)</sub> (Typ.)	280mΩ
I <sub>D</sub>	14A
$P_D$	108W

# Outline TO-247N

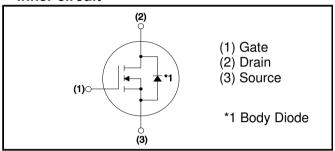
#### Features

- 1) Low on-resistance
- 2) Fast switching speed
- 3) Fast reverse recovery
- 4) Easy to parallel
- 5) Simple to drive
- 6) Pb-free lead plating; RoHS compliant
- 7) Qualified to AEC-Q101

#### Application

- Automobile
- · Switch mode power supplies

#### •Inner circuit



#### Packaging specifications

Pack	age	TO-247N
	Packing	Tube
	Reel size (mm)  Tape width (mm)	-
Typo		-
Туре	Basic ordering unit (pcs)	30
	Packing code	C11
	Marking	SCT2280KE

## ● Absolute maximum ratings (T<sub>a</sub> = 25°C)

Parameter		Symbol	Value	Unit
Drain - Source voltage		V <sub>DSS</sub>	1200	V
Continuous drain current	T <sub>c</sub> = 25°C	I <sub>D</sub> *1	14	А
	T <sub>c</sub> = 100°C	l <sub>D</sub> *1	10	А
Pulsed drain current		I <sub>D,pulse</sub> *2	35	А
Gate - Source voltage (DC)		V <sub>GSS</sub>	-6 to 22	V
Gate - Source surge voltage (T <sub>surge</sub> < 300nsec)		$V_{\rm GSS\_surge}^{*3}$	–10 to 26	V
Power dissipation (T <sub>c</sub> = 25°C)		P <sub>D</sub>	108	W
Junction temperature		T <sub>j</sub>	175	°C
Range of storage temperature		T <sub>stg</sub>	-55 to +175	°C

# • Electrical characteristics $(T_a = 25^{\circ}C)$

Parameter	Symbol	Conditions	Values			Unit
ı arameter	Symbol	Conditions	Min.	Тур.	Max.	Offic
Drain - Source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V$ , $I_D = 1mA$	1200	1	-	V
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{DS}$ = 1200V, $V_{GS}$ = 0V $T_j$ = 25°C $T_j$ = 150°C	1 1	1 2	10	μΑ
Gate - Source leakage current	I <sub>GSS+</sub>	$V_{GS} = +22V, V_{DS} = 0V$	ı	1	100	nA
Gate - Source leakage current	I <sub>GSS-</sub>	$V_{GS} = -6V, V_{DS} = 0V$	-	-	-100	nA
Gate threshold voltage	V <sub>GS (th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 1.4 \text{mA}$	1.6	2.8	4.0	V

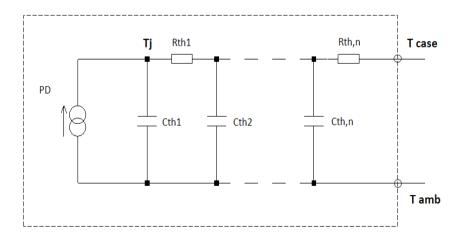
#### ●Thermal resistance

Parameter	Symbol	Values			Unit
Farameter	Symbol	Min.	Тур.	Max.	Utilit
Thermal resistance, junction - case	$R_{thJC}$	ı	1.07	1.39	°C/W
Thermal resistance, junction - ambient	$R_{thJA}$	-	-	50	°C/W
Soldering temperature, wavesoldering for 10s	T <sub>sold</sub>	-	-	265	°C

### ● Typical Transient Thermal Characteristics

Symbol	Value	Unit
R <sub>th1</sub>	1.00E-01	
R <sub>th2</sub>	6.62E-01	K/W
R <sub>th3</sub>	3.04E-01	

Symbol	Value	Unit
C <sub>th1</sub>	8.61E-04	
C <sub>th2</sub>	2.84E-03	Ws/K
C <sub>th3</sub>	5.59E-02	



# •Electrical characteristics $(T_a = 25^{\circ}C)$

Davamatav	Cymphal	Conditions	Values			Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Offic
		$V_{GS} = 18V, I_D = 4A$				
Static drain - source on - state resistance	R <sub>DS(on)</sub> *4	T <sub>j</sub> = 25°C	-	280	364	mΩ
		T <sub>j</sub> = 125°C	-	388	-	
Gate input resistance	$R_{G}$	f = 1MHz, open drain	-	17	-	Ω
Transconductance	g <sub>fs</sub> *4	$V_{DS} = 10V, I_D = 4A$	-	1.4	-	S
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0V$	-	667	-	
Output capacitance	C <sub>oss</sub>	$V_{DS} = 800V$	-	27	-	pF
Reverse transfer capacitance	C <sub>rss</sub>	f = 1MHz	-	5	-	
Effective output capacitance, energy related	C <sub>o(er)</sub>	$V_{GS} = 0V$ $V_{DS} = 0V$ to 500V	-	41	-	pF
Turn - on delay time	t <sub>d(on)</sub> *4	$V_{DD} = 400V, V_{GS} = 18V$	-	19	-	
Rise time	t <sub>r</sub> *4	$I_D = 4A$	-	19	-	
Turn - off delay time	t <sub>d(off)</sub> *4	$R_L = 100\Omega$	-	47	-	ns
Fall time	t <sub>f</sub> *4	$R_G = 0\Omega$	-	29	-	
Turn - on switching loss	E <sub>on</sub> *4	$V_{DD} = 600V, I_{D} = 4A$ $V_{GS} = 18V/0V$	-	57	-	1
Turn - off switching loss	E <sub>off</sub> *4	$R_G = 0\Omega$ , L=500 $\mu$ H *E <sub>on</sub> includes diode reverse recovery	-	20	-	μJ

## •Gate Charge characteristics $(T_a = 25^{\circ}C)$

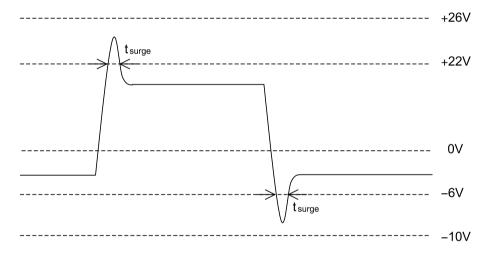
Parameter	Symbol	Conditions	Values			Unit
			Min.	Тур.	Max.	Offic
Total gate charge	$Q_g^{*4}$	$V_{DD} = 400V$	-	36	-	
Gate - Source charge	Q <sub>gs</sub> *4	$I_D = 4A$	-	9	-	nC
Gate - Drain charge	Q <sub>gd</sub> *4	V <sub>GS</sub> = 18V	-	12	-	
Gate plateau voltage	V <sub>(plateau)</sub>	$V_{DD} = 400V, I_D = 4A$	-	9.8	-	V

# ullet Body diode electrical characteristics (Source-Drain) (T<sub>a</sub> = 25°C)

Parameter	Symbol	Conditions	Values			Unit
r arameter	Syllibol	Conditions	Min.	Тур.	Max.	Offic
Inverse diode continuous, forward current	l <sub>S</sub> *1	T <sub>c</sub> = 25°C	ı	1	14	Α
Inverse diode direct current, pulsed	I <sub>SM</sub> *2		-	-	35	Α
Forward voltage	$V_{SD}^{*4}$	$V_{GS} = 0V, I_{S} = 4A$	ı	4.0	-	V
Reverse recovery time	t <sub>rr</sub> *4		ı	22	-	ns
Reverse recovery charge	Q <sub>rr</sub> *4	I <sub>F</sub> = 4A, V <sub>R</sub> = 400V di/dt = 160A/μs	ı	21	-	nC
Peak reverse recovery current	l <sub>rrm</sub> *4		-	2.0	-	Α

<sup>\*1</sup> Limited only by maximum temperature allowed.

<sup>\*3</sup> Example of acceptable  $V_{\text{GS}}$  waveform



\*4 Pulsed

<sup>\*2</sup> PW  $\leq$  10 $\mu$ s, Duty cycle  $\leq$  1%

Fig.1 Power Dissipation Derating Curve

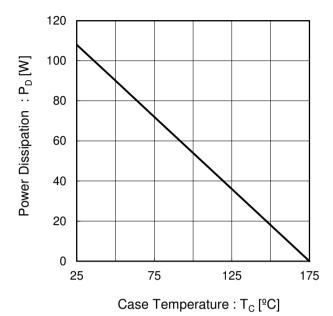


Fig.2 Maximum Safe Operating Area

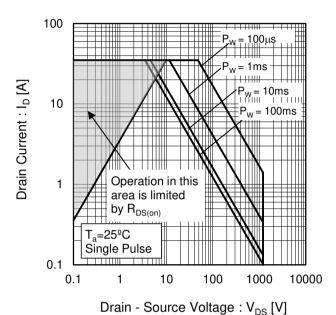


Fig.3 Typical Transient Thermal Resistance vs. Pulse Width

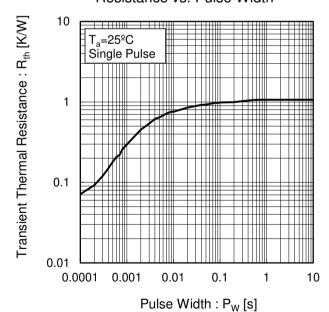


Fig.4 Typical Output Characteristics(I)

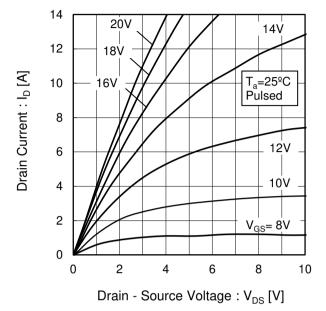
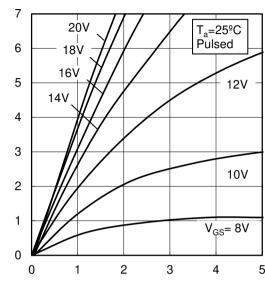


Fig.5 Typical Output Characteristics(II)



Drain Current : I<sub>D</sub> [A]

Drain - Source Voltage : V<sub>DS</sub> [V]

Fig.6 T<sub>j</sub> = 150°C Typical Output Characteristics(I)

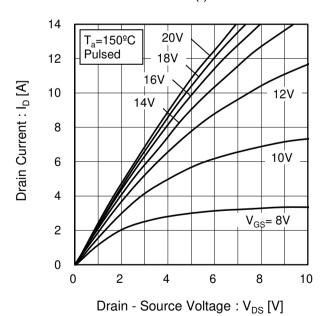
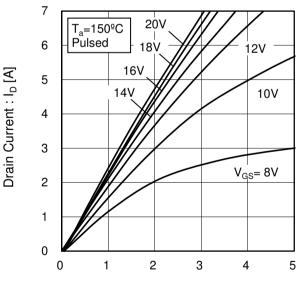


Fig.7 T<sub>j</sub> = 150°C Typical Output Characteristics(II)



Drain - Source Voltage: V<sub>DS</sub> [V]

Fig.8 Typical Transfer Characteristics (I)

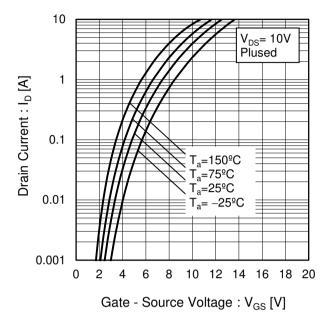


Fig.9 Typical Transfer Characteristics (II)

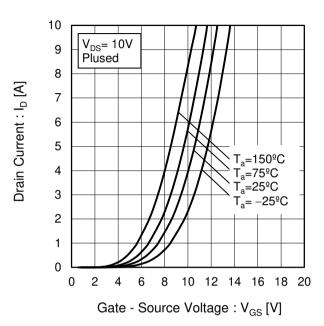


Fig.10 Gate Threshold Voltage vs. Junction Temperature

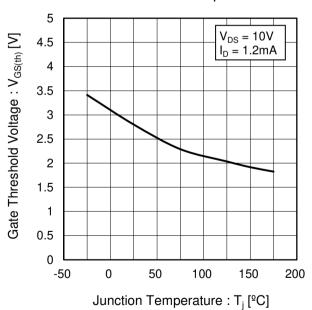


Fig.11 Transconductance vs. Drain Current

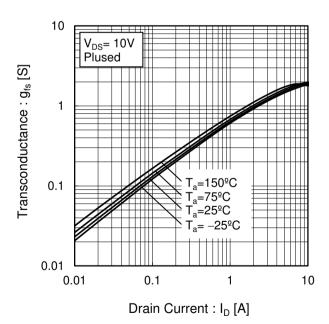


Fig.12 Static Drain - Source On - State Resistance vs. Gate Source Voltage

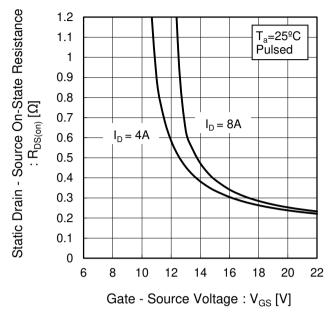


Fig.13 Static Drain - Source On - State Resistance vs. Junction Temperature

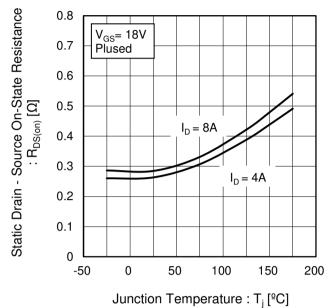


Fig.14 Static Drain - Source On - State Resistance vs. Drain Current

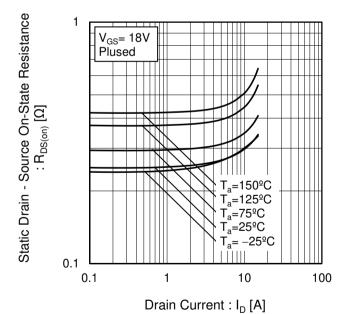


Fig.15 Typical Capacitance vs. Drain - Source Voltage

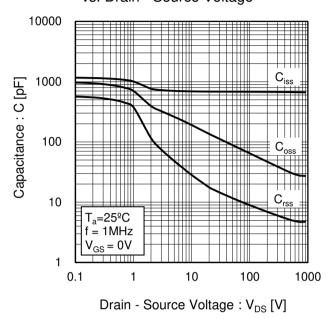


Fig.16 C<sub>OSS</sub> Stored Energy

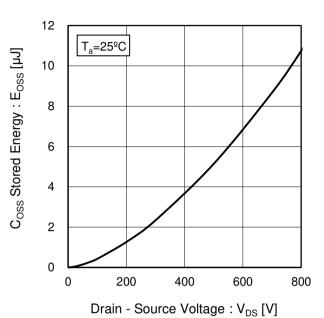


Fig.17 Switching Characteristics

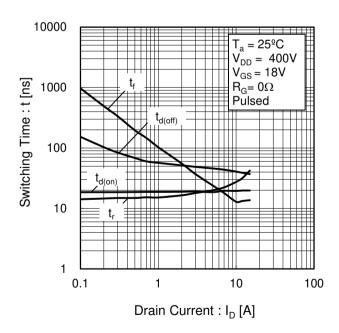


Fig.18 Dynamic Input Characteristics

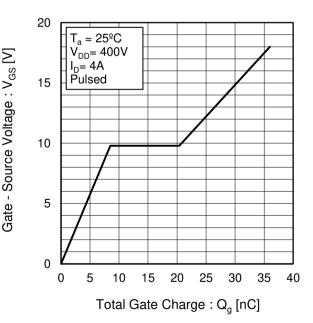


Fig.19 Typical Switching Loss vs. Drain - Source Voltage

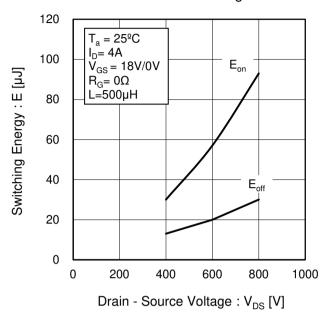


Fig.20 Typical Switching Loss vs. Drain Current

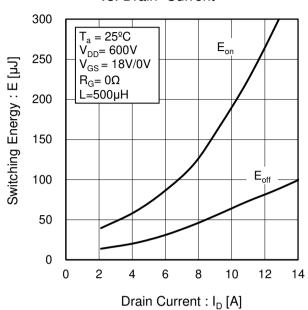
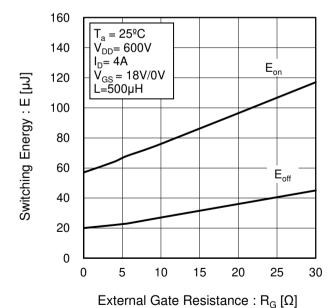


Fig.21 Typical Switching Loss vs. External Gate Resistance



SCT2280KEHR

Fig.22 Inverse Diode Forward Current vs. Source - Drain Voltage

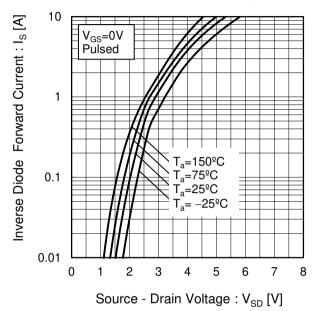
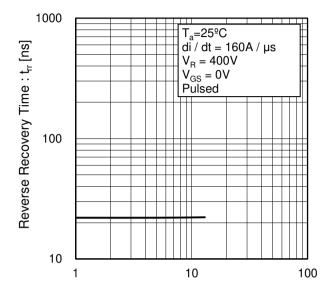


Fig.23 Reverse Recovery Time vs.Inverse Diode Forward Current



#### Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

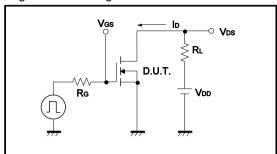


Fig.2-1 Gate Charge Measurement Circuit

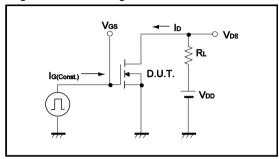


Fig.3-1 Switching Energy Measurement Circuit

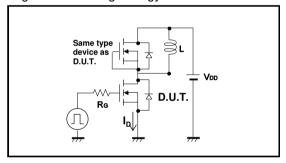


Fig.4-1 Reverse Recovery Time Measurement Circuit Fig.4-2 Reverse Recovery Waveform

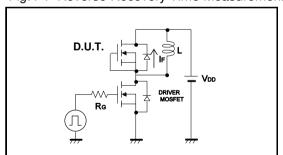


Fig.1-2 Switching Waveforms

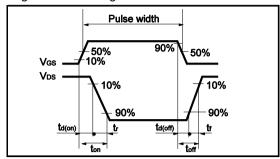


Fig.2-2 Gate Charge Waveform

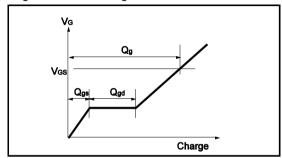
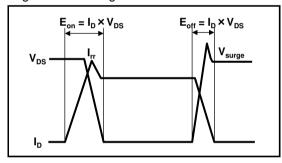
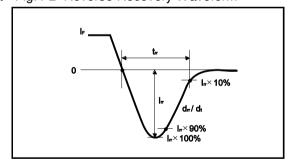


Fig.3-2 Switching Waveforms





#### Notes

- 1) The information contained herein is subject to change without notice.
- Before you use our Products, please contact our sales representative and verify the latest specifications
- 3) Although ROHM is continuously working to improve product reliability and quality, semiconductors can break down and malfunction due to various factors.

  Therefore, in order to prevent personal injury or fire arising from failure, please take safety measures such as complying with the derating characteristics, implementing redundant and fire prevention designs, and utilizing backups and fail-safe procedures. ROHM shall have no responsibility for any damages arising out of the use of our Poducts beyond the rating specified by ROHM.
- 4) Examples of application circuits, circuit constants and any other information contained herein are provided only to illustrate the standard usage and operations of the Products. The peripheral conditions must be taken into account when designing circuits for mass production.
- 5) The technical information specified herein is intended only to show the typical functions of and examples of application circuits for the Products. ROHM does not grant you, explicitly or implicitly, any license to use or exercise intellectual property or other rights held by ROHM or any other parties. ROHM shall have no responsibility whatsoever for any dispute arising out of the use of such technical information.
- 6) The Products specified in this document are not designed to be radiation tolerant.
- 7) For use of our Products in applications requiring a high degree of reliability (as exemplified below), please contact and consult with a ROHM representative: transportation equipment (i.e. cars, ships, trains), primary communication equipment, traffic lights, fire/crime prevention, safety equipment, medical systems, and power transmission systems.
- 8) Do not use our Products in applications requiring extremely high reliability, such as aerospace equipment, nuclear power control systems, and submarine repeaters.
- 9) ROHM shall have no responsibility for any damages or injury arising from non-compliance with the recommended usage conditions and specifications contained herein.
- 10) ROHM has used reasonable care to ensure the accuracy of the information contained in this document. However, ROHM does not warrants that such information is error-free, and ROHM shall have no responsibility for any damages arising from any inaccuracy or misprint of such information.
- 11) Please use the Products in accordance with any applicable environmental laws and regulations, such as the RoHS Directive. For more details, including RoHS compatibility, please contact a ROHM sales office. ROHM shall have no responsibility for any damages or losses resulting non-compliance with any applicable laws or regulations.
- 12) When providing our Products and technologies contained in this document to other countries, you must abide by the procedures and provisions stipulated in all applicable export laws and regulations, including without limitation the US Export Administration Regulations and the Foreign Exchange and Foreign Trade Act.
- 13) This document, in part or in whole, may not be reprinted or reproduced without prior consent of ROHM.



Thank you for your accessing to ROHM product informations. More detail product informations and catalogs are available, please contact us.

## ROHM Customer Support System

http://www.rohm.com/contact/

#### **General Precaution**

- 1. Before you use our Products, you are requested to care fully read this document and fully understand its contents. ROHM shall not be in an y way responsible or liable for failure, malfunction or accident arising from the use of a ny ROHM's Products against warning, caution or note contained in this document.
- 2. All information contained in this docume nt is current as of the issuing date and subject to change without any prior notice. Before purchasing or using ROHM's Products, please confirm the latest information with a ROHM sale s representative.
- 3. The information contained in this doc ument is provided on an "as is" basis and ROHM does not warrant that all information contained in this document is accurate an d/or error-free. ROHM shall not be in an y way responsible or liable for any damages, expenses or losses incurred by you or third parties resulting from inaccuracy or errors of or concerning such information.

**Notice – WE** © 2015 ROHM Co., Ltd. All rights reserved. Rev.001